



RECOMMENDED PCB LAYOUT

NOTES:

1. MATERIALS:
 BASE METAL: HIGH CONDUCTIVE COPPER ALLOY
 PLATING ON BODY: 3.18 MICRON MIN SILVER OVER 1.27 MICRON MIN NICKEL
2. PRODUCT SPECIFICATION: 2043130006-PS
3. APPLICATION SPECIFICATION: 2043130006-AS
4. PACKAGING SPECIFICATION: 2032630006-PK
5. SILVER COMPONENTS WILL BE SUPPLIED TARNISH FREE BUT MAY TARNISH OVER TIME
6. MINIMUM RECOMMENED PCB THICKNESS 1.58MM

PART NUMBER	DIMENSION "L"
203263-0106	26.00
203263-0116	20.00
203263-0126	14.00
203263-0136	31.75
203263-0146	29.50
203263-0156	16.00

(A2)

FUNCTIONAL SYMBOLS FA = 0 FC = 0 FD = 0	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		CURRENT REV DESC: PRODUCTION RELEASE		molex
	DIMENSION UNITS mm	SCALE 5:1			
DIVISIONAL SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		EC NO: 639507		6.0MM CST STD (SMT), MALE PIN
	ANGULAR TOL ± 0.5°		DRWN: GJEEVANSURES 2020/06/02		
	4 PLACES ±	DRWN: GJEEVANSURES 2020/06/16		PRODUCT CUSTOMER DRAWING	
	3 PLACES ±	CHK'D: GJEEVANSURES 2020/06/16			
2 PLACES ± 0.15	APPR: HTHYAGARAJ 2020/06/16		DOCUMENT NUMBER 2032630136-SD		
1 PLACE ± 0.25	INITIAL REVISION: DRWN: RLOW 2019/06/05				DOC TYPE PSD
0 PLACES ±	APPR: BPISZCZOR 2019/06/10		MATERIAL NUMBER SEE TABLE		CUSTOMER GENERAL MARKET
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION			